SMAP

Washable

Surface Mount Pushbutton Switches

RoHS Compliant



- Features
- Compatible with Reflow Soldering
- Washable
- Gold-Plated Contacts for Low Current Application
- Clip Contact Mechanism for High Contact Reliability

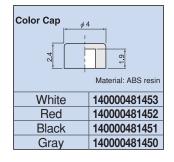
Specifications

Rating	Max.	0.4VA (28	VDC max.)	(Resistive load)
	Min.	1μA 20m\	/DC	(Resistive load)
Initial contact resistance		100m Ω max. (1.5mA 200 μ VAC		5mA 200 μ VAC)
Dielectric strength		250VAC 1minute		
Initial insulation resistance		500M Ω min. (250VD		(250VDC)
Stroke		1.4mm		
Operating force		1.47±0.98 N		
Electrostatic capacity		5pF max.	10,000 operations at max. rating	
Electrical life		30,000 operations at min. rating		
Switch timing		Non-shorting		
Operating temperature range		-20~+80°C		
Storage temperature range		-40~+80°C		

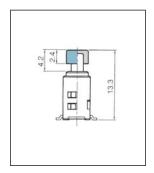
■ Table of Part Numbers

Packaging	Terminal	Switching	Poles	
specifications	styles	function	1 pole	2 poles
Stick	PC	ON-(ON)	SMAP1F-2M-Z	SMAP2F-2M-Z
	Right-angle	ON-(ON)	SMAP1F-5M-Z	SMAP2F-5M-Z
Emboss taping	Right-angle	ON-(ON)	SMAP1F-5M-E-Z	SMAP2F-5M-E-Z

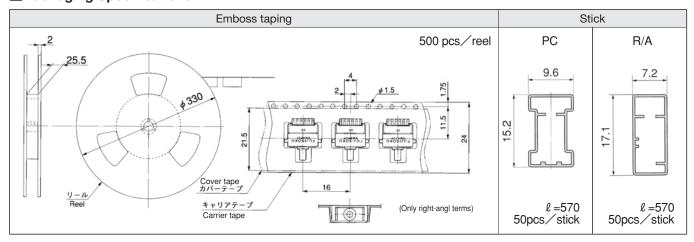
Optional Accessories (Sold separately)



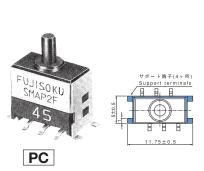
■ Color Cap Mounting —

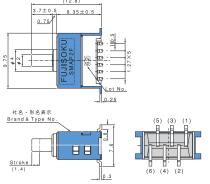


■Packaging Specifications



SMAP-2M

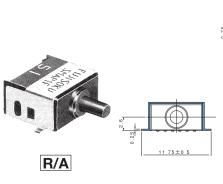


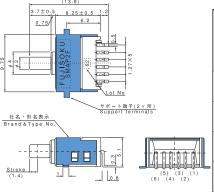


Terminal numbers are not shown on the switch.

Switching function Part No.	1	Push
☆SMAP1F-2M-Z	ON	(ON)
Connecting terminals	2-3	2-1
☆SMAP2F-2M-Z	ON	(ON)
Connecting terminals	2-3 5-4	2-1 5-6

SMAP-5M





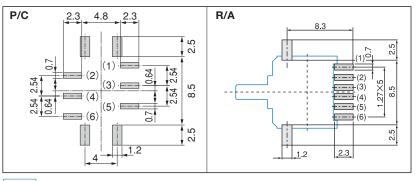
Terminal numb	pers are not	shown on th	e switch.

Switching function Part No.	1	Push
SMAP1F-5M-Z SMAP1F-5M-E-Z	ON	(ON)
Connecting terminals	2-3	2-1
★SMAP2F-5M-Z ★SMAP2F-5M-E-Z	ON	(ON)
Connecting terminals	2-3 5-4	2-1 5-6

(ON): Momentary

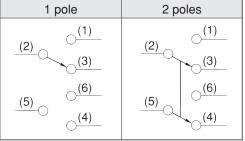
■Pad Layouts





The blue line shows the outline of the switch.

■Circuit Diagrams



In a single-pole configuration, terminals (4), (5) and (6) are not connected.

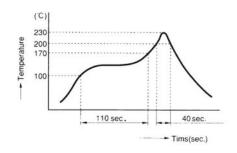
■Soldering Specifications

(1) Manual Soldering

Device : Soldering iron $380^{\circ}\text{C} \pm 10^{\circ}\text{C}$; 3 ± 0.5 seconds

(2) Reflow Soldering

Device: Inline or batch system
•Apply reflow soldering only once



■Flux Cleaning

- (1) Solvent : Fluorine or Alcohol type
- (2) Cleaning after soldering should be done after the terminal temperature falls to 90°C or below, or after leaving the switch for five minutes or longer at room temperature.
- (3) Do not use ultrasonic cleaning.

(ON) : Momentary.

☆: Semi-standard products.

★ : Made to order products.